belkin

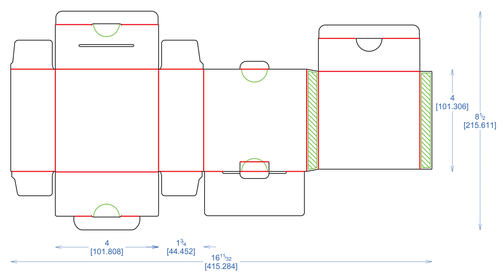
Die Line File: IDL_WIN 222_15W WIRELESS CHARGING PAD WITH USB-C CABLE US

Artwork File:

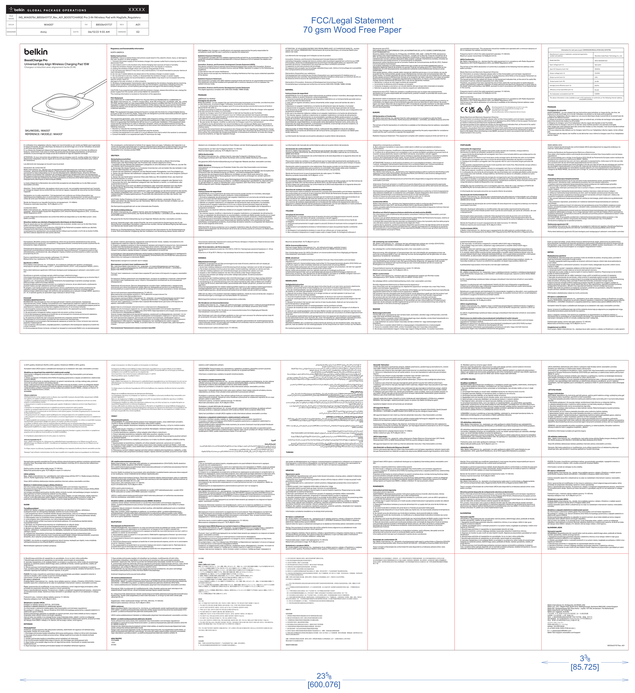
REV 0 00

DIE LAYOUT

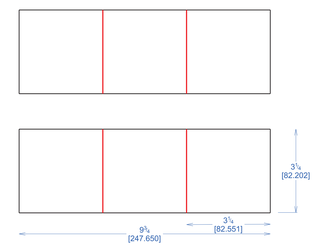
BOM - WCA003 US APL	P#
Outer	Refer Artwork
RC Statement	Refer Artwork
Paper Platform	Refer Artwork
Wafer Seal (2 pc)	25 mm
Hanger must be folded in the case pack	



FCC/Legal Statement
70 gsm Wood Free Paper



QIG
70 gsm Wood Free Paper



Business Unit: Core

Program Manager:

Packaging Engineer: Matthew Duffy

Retail Outside Dimension (Including Hang Tab)

L x W x D (in): 0 x 0 x 0

L x W x D (mm): 0.00 x 0.00 x 0.00

DIE/MATERIAL SPECS:

Material: 350gsm C1S SBS (20pt)

Blank Size (in): 59.686 x 15+9/16

Blank Size (mm): 1516.034 x 395.290

This dieline works for following skus (if any):

Unit: IN/MM

Side Shown: PRINT SIDE

Flute/Grain: horizontal

Tolerance:+/- 1/32" - 0.8mm

Drawing Scale 1:1

RELEASE DATE: 04/06/2023

DIELINE:

Intermediate

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PRINT SPECS:

Color Plates:

Finish:

Notes:

DO NOT PRINT
DIE LINES, PRINTERS NOTES